

## MAC97A6,MAC97A8 Series

#### Description:

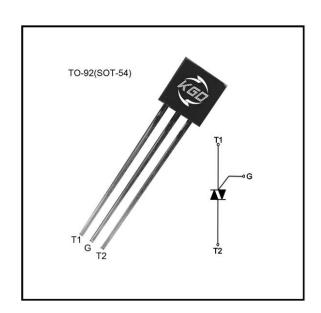
Logic level sensitive gate triac intended to interfaced directly to microcontrollers,logic integrated circuits and other low power gate trigger circuits.

#### Applications

This device is suitable for low power AC switching application, phase control application such as fan speed and temperature modulation control, lighting control and static switching relay.

#### Features:

Blocking voltage to 400/600V On-state RMS current to 0.8A Non-repetitive peak on-state current to 8A



#### Absolute Maximum Ratings

Symbol	Parameter	Conditions	Value		Unit
			97A6	97A8	
$V_{DRM}$	Repetitive peak off-state voltage	T <sub>J</sub> =25°C	400 600		V
$V_{RRM}$	Repetitive peak Reverse voltage	T <sub>J</sub> =25°C	400	600	V
I <sub>T(RMS)</sub>	RMS on-state current (full sine wave)	T <sub>c</sub> =110°C	0.8		Α
I <sub>T(av)</sub>	Average on-state current (full sine wave)	T <sub>c</sub> =110°C	0.5		А
L	Non-repetitive surge peak On-state current	tp=10ms	8		A
I <sub>TSM</sub>	(One full cycle,sine wave,T <sub>C</sub> =110°C)	tp=8.3ms	8.3		
l <sup>2</sup> t	I <sup>2</sup> t Value for fusing	tp=10ms	0.32		A <sup>2</sup> S
$I_{GM}$	Peak gate current	tp≤2μs, T <sub>J</sub> =80°C	1		Α
$P_{G(AV)}$	Average gate power dissipation	to<10ma T 90°C	0.1		W
PGM	Peak gate power dissipation	tp≤10ms, T <sub>J</sub> =80°C	1		W
T <sub>STG</sub>	Storage temperature		-40 150		${\mathbb C}$
T <sub>J</sub>	Junction temperature		-40 125		${\mathbb C}$



# MAC97A6,MAC97A8 Series

#### Electrical Characteristics

Symbol	Conditions	Quadrant	Value		11.26
			MIN	MAX	- Unit
I <sub>GT</sub>	$V_D=12V,R_L=33\Omega$	I - II -III	/	5	mA
		IV	/	7	
$V_{GT}$		ALL	/	1.5	V
$V_{GD}$	$V_D = V_{DRM}, R_L = 3.3 K\Omega, T_J = 125 ^{\circ}\mathrm{C}$	ALL	0.2	/	V
IL	I <sub>G</sub> =1mA	ALL	1	10	mA
I <sub>H</sub>	I <sub>T</sub> =200mA		1	5	mA
dv/dt	$V_{DM}$ =67% $V_{DRM}$ , gate open, $T_J$ =125°C		25	/	V/µs

#### Electrical Characteristics

Symbol		Parameter	Numerical	Unit
$V_{TM}$	I <sub>T</sub> =1.1A,tp=380μs	T <sub>J</sub> =25℃	1.5	V
I <sub>DRM</sub>	V V V	T <sub>J</sub> =25℃	5	μΑ
I <sub>DRM</sub>	$V_D = V_{DRM}, V_R = V_{RRM}$		0.1	mA

#### • Thermal Characteristics

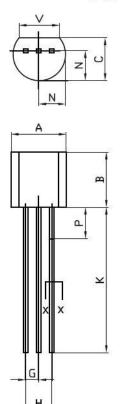
Symbol	Parameter	Numerical(MAX)	Unit
R <sub>th(j-c)</sub>	Junction to case(AC)	75	°C/W
R <sub>th(j-a)</sub>	Junction to ambient(AC)	150	°C/W



# MAC97A6,MAC97A8 Series

### Package Outline Dimensions

TO-92 (SOT-54)





SECTION X-X

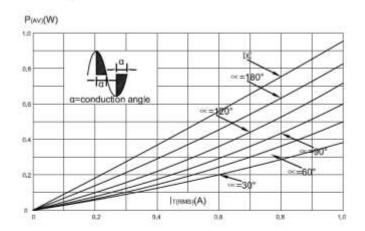
;	Dimensions				
Ref.	Millimeters		Inc	Inches	
	Min.	Max.	Min.	Max.	
Α	4.45	5.2	0.175	0.205	
В	4.32	5.33	0.170	0.210	
С	3.18	4.19	0.125	0.165	
D	0.407	0.533	0.016	0.021	
G	1.15	1.39	0.045	0.055	
Н	2.42	2.66	0.095	0.105	
J	0.39	0.50	0.015	0.020	
K	12.70	3 (1995) 3 (1995) 4 (1995)	0.500		
N	2.04	2.66	0.080	0.105	
Р	<b>=</b> 0	2.54	8 <b>—</b>	0.100	
V	3.43	-	0.135	<b></b> 0	



### MAC97A6, MAC97A8 Series

FIG.2: RMS on-state current versus

FIG.1: Maximum power dissipation versus average on-state current.



temperature.

IT(RMS)(A)

FIG.3: On-state characteristics (maximum values)

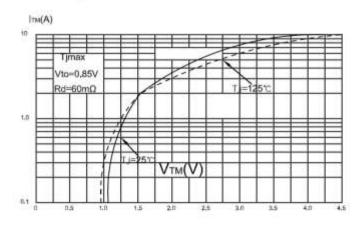


FIG.4: Surge peak on-state current versus number of cycles.

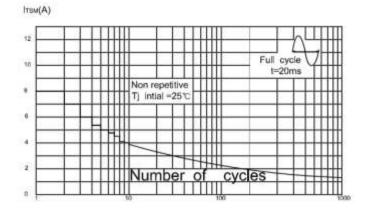


FIG.5: Relative variation of gate trigger current, holding current and latching current versus junction temperature(typical values).

